MOSFETs Silicon P-Channel MOS

SSM6J825R

1. Applications

- Power Management Switches

2. Features

(1) 4.0-V drive

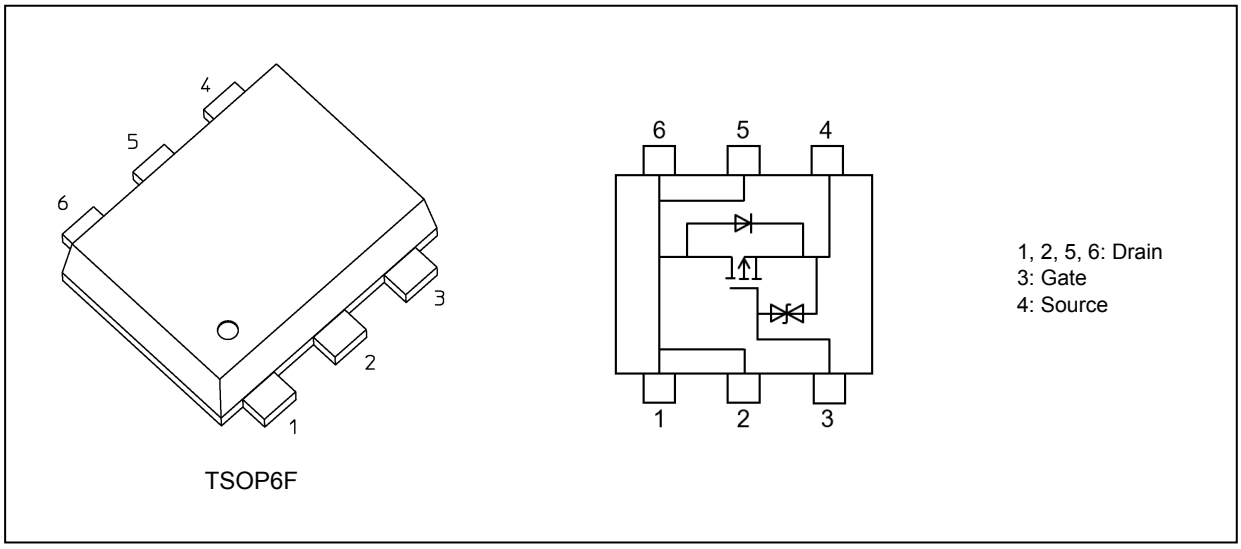
(2) Low drain-source on-resistance

: $R_{DS(ON)}$ = 86 mΩ (max) ($@V_{GS}$ = -4.0 V)

$R_{DS(ON)}$ = 73 mΩ (max) ($@V_{GS}$ = -4.5 V)

$R_{DS(ON)}$ = 45 mΩ (max) ($@V_{GS}$ = -10 V)

3. Packaging and Pin Assignment



Start of commercial production

2021-12

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4. Absolute Maximum Ratings (Note) (Unless otherwise specified, T_a = 25 °C)

Characteristics			Symbol	Rating	Unit
Drain-source voltage			V_{DSS}	-30	V
Gate-source voltage			V_{GSS}	-20 / +10	
Drain current (DC)		(Note 1)	I_D	-4	A
Drain current (pulsed)		(Note 1), (Note 2)	I_{DP}	-12	
Power dissipation		(Note 3)	P_D	1.5	W
Power dissipation	t ≤ 10 s	(Note 3)	P_D	3	
Channel temperature			T_{ch}	150	°C
Storage temperature			T_{stg}	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Ensure that the channel temperature does not exceed 150 °C.

Note 2: Repetitive rating; pulse width limited by maximum channel temperature.

Note 3: Device mounted on an FR4 board.(25.4 mm × 25.4 mm × 1.6 mm, Cu pad: 645 mm^2)

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

Note: The MOSFETs in this device are sensitive to electrostatic discharge. When handling this device, the worktables, operators, soldering irons and other objects should be protected against anti-static discharge.

Note: The channel-to-ambient thermal resistance, $R_{th(ch-a)}$, and the drain power dissipation, P_D, vary according to the board material, board area, board thickness and pad area. When using this device, be sure to take heat dissipation fully into account.

5. Thermal Characteristics

Characteristics		Symbol	Max	Unit
Channel-to-ambient thermal resistance	(Note 1)	$R_{th(ch-a)}$	83	°C/W

Note 1: Device mounted on an FR4 board.(25.4 mm × 25.4 mm × 1.6 mm, Cu pad: 645 mm^2)

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6. Electrical Characteristics

6.1. Static Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		I_{GSS}	V_{DS} = 0 V, V_{GS} = -16/+10 V	—	—	±1	μA
Drain cut-off current		I_{DSS}	V_{DS} = -30 V, V_{GS} = 0 V	—	—	-1	
Drain-source breakdown voltage		$V_{(BR)DSS}$	I_D = -250 μA, V_{GS} = 0 V	-30	—	—	V
Drain-source breakdown voltage		$V_{(BR)DSX}$	I_D = -250 μA, V_{GS} = 10 V	-20	—	—	
Gate threshold voltage		V_{th}	V_{DS} = 10 V, I_D = -250 μA	-0.9	—	-2.0	V
Drain-source on-resistance	(Note 1)	$R_{DS(ON)}$	I_D = -1.0 A, V_{GS} = -4.0 V	—	61	86	mΩ
			I_D = -4.0 A, V_{GS} = -4.5 V	—	55	73	
		$R_{DS(ON)}$	I_D = -4.0 A, V_{GS} = -10 V	—	35	45	mΩ
Forward transfer admittance	(Note 1)	$\|Y_{fs}\|$	V_{DS} = -10 V, I_D = -2.0 A	—	7.1	—	S

Note 1: Pulse measurement.

6.2. Dynamic Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Input capacitance	C_{iss}	V_{DS} = -10 V, V_{GS} = 0 V, f = 1 MHz	—	492	—	pF
Reverse transfer capacitance	C_{rss}		—	75	—	
Output capacitance	C_{oss}		—	97	—	
Switching time (turn-on time)	t_{on}	V_{DS} = -15 V, I_D = -2 A, V_{GS} = 0 to -4.5 V, R_{GS} = 10 Ω	—	49	—	ns
Switching time (turn-off time)	t_{off}		—	80	—	

6.3. Switching Time Test Circuit

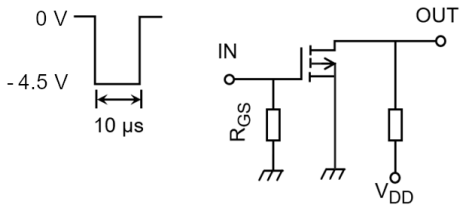


Fig. 6.3.1 Switching Time Test Circuit

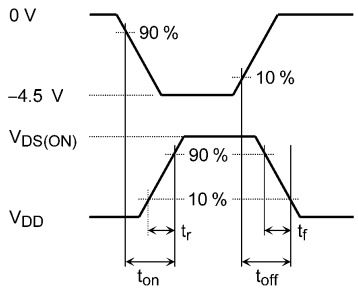


Fig. 6.3.2 Input Waveform/Output Waveform

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6.4. Gate Charge Characteristics (Unless otherwise specified, T_a = 25 °C)

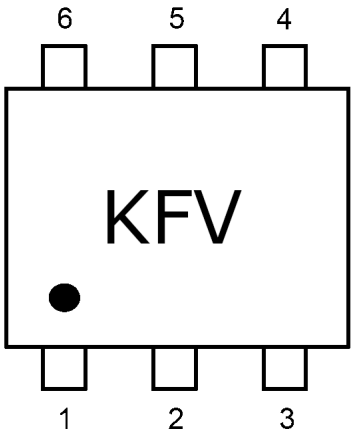
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Q_g	V_{DD} = -15 V, I_D = -4.0 A, V_{GS} = -4.5 V	—	6.2	—	nC
Gate-source charge 1	Q_{gs1}		—	1.5	—	
Gate-drain charge	Q_{gd}		—	2.8	—	

6.5. Source-Drain Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Diode forward voltage	(Note 1)	V_{DSF}	I_{DR} = 4.0 A, V_{GS} = 0 V	—	0.85	1.1	V

Note 1: Pulse measurement.

7. Marking



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8. Characteristics Curves (Note)

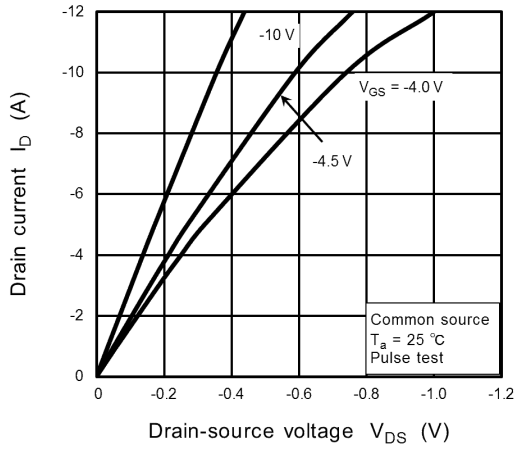


Fig. 8.1 I_D - V_{DS}

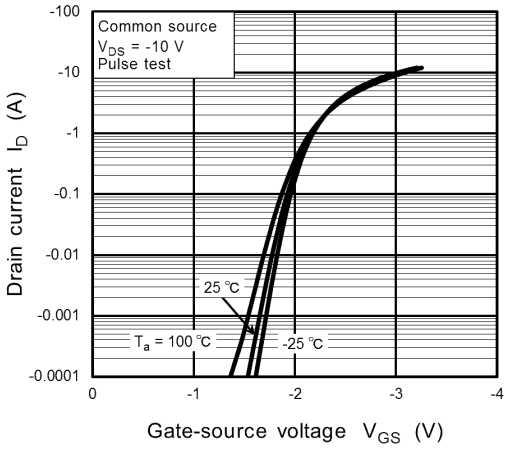


Fig. 8.2 I_D - V_{GS}

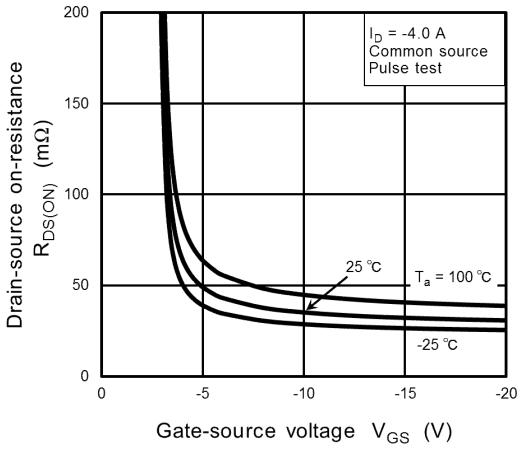


Fig. 8.3 $R_{DS(ON)}$ - V_{GS}

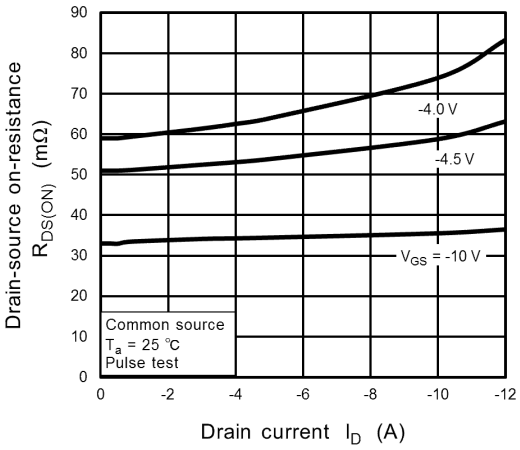


Fig. 8.4 $R_{DS(ON)}$ - I_D

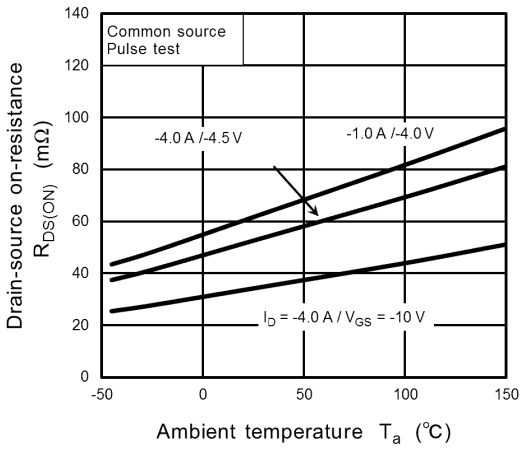


Fig. 8.5 $R_{DS(ON)}$ - T_a

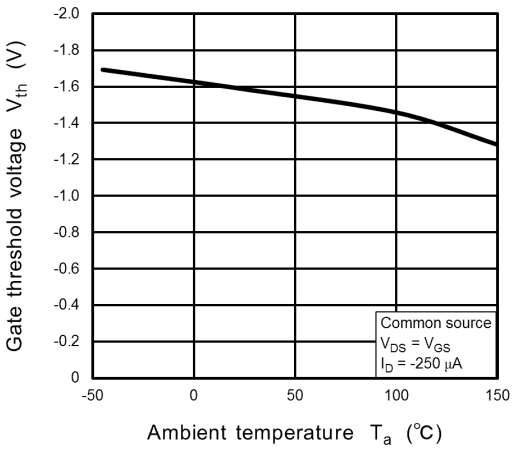


Fig. 8.6 V_{th} - T_a

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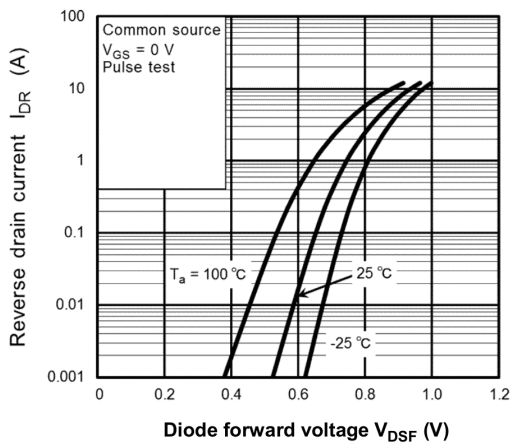


Fig. 8.7 I_{DR} - V_{DSF}

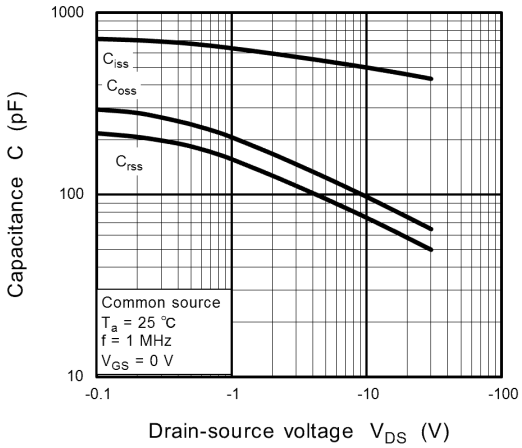


Fig. 8.8 C - V_{DS}

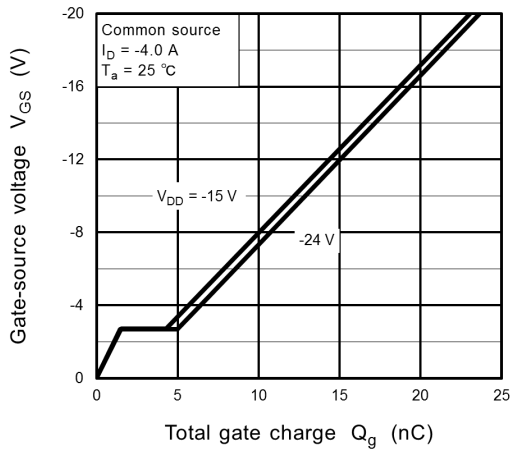


Fig. 8.9 Dynamic Input Characteristics

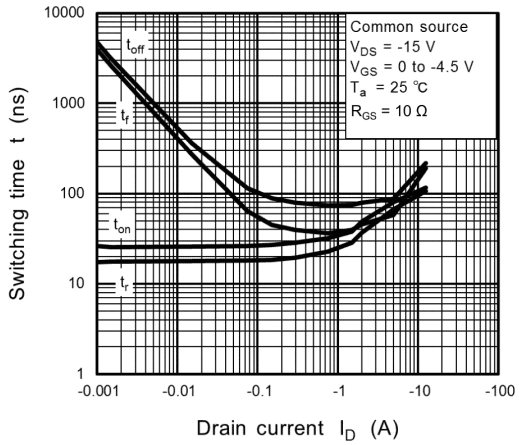


Fig. 8.10 t - I_D

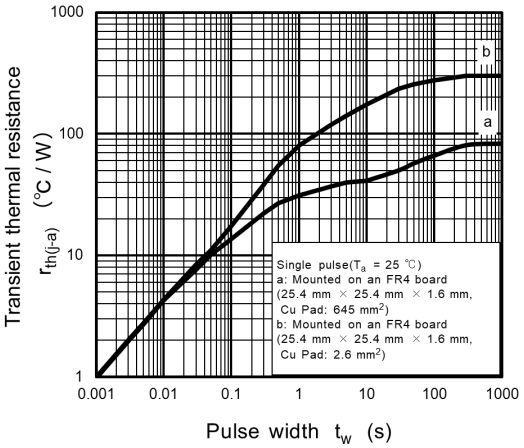


Fig. 8.11 $r_{th(j-a)}$ - t_w

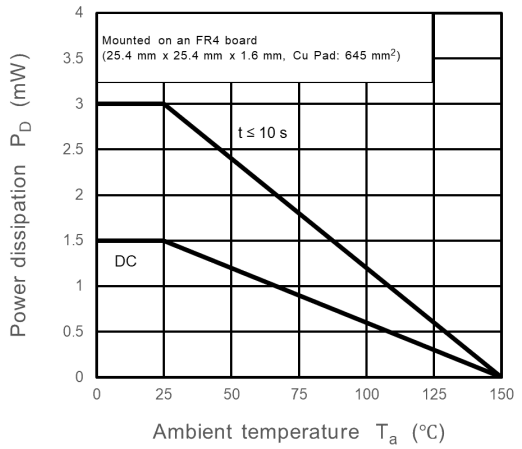


Fig. 8.12 P_D - T_a

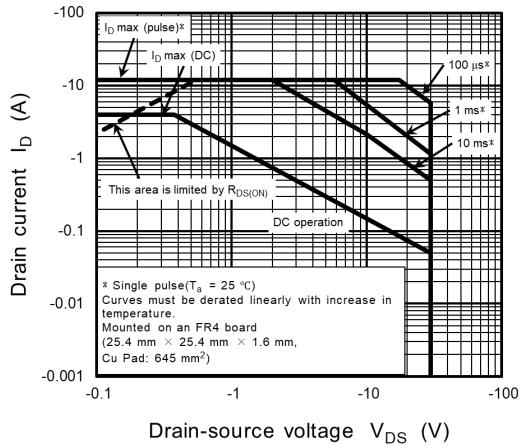
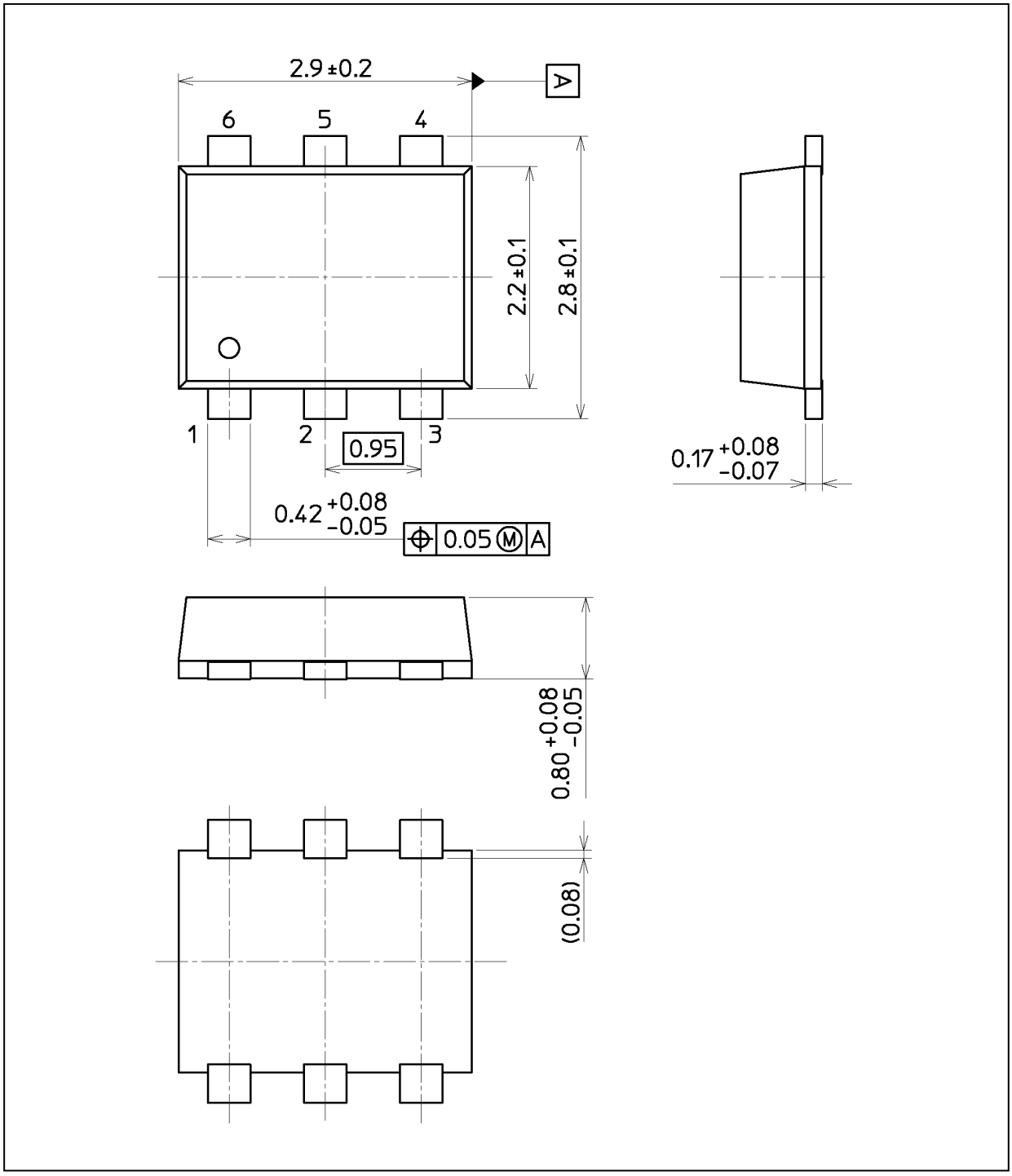


Fig. 8.13 Safe Operating Area

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Package Dimensions

Unit: mm



Weight: 0.016 g (typ.)

Package Name(s)
Nickname: TSOP6F

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